onsemi

Quad 2-Input NAND Gate

MC74VHC00, MC74VHCT00A

The MC74VHC00 and MC74VHCT00A are high speed CMOS quad 2-input NAND gate fabricated with silicon gate CMOS technology. These achieve high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

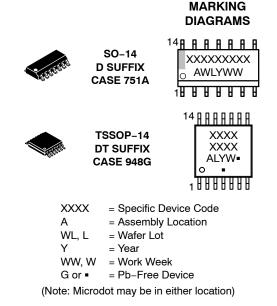
The MC74VHC00 inputs are compatible with standard CMOS levels while the MC74VHCT00A inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5.0 V CMOS level output swings.

The MC74VHC00 and MC74VHCT00A internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The input structures tolerate voltages up to 5.5 V, allowing the interface of 5 V systems to 3 V systems.

The MC74VHCT00A output structures provide protection when $V_{CC} = 0$ V. These output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

Features

- High Speed: $t_{PD} = 3.7$ ns (Typ) at $V_{CC} = 5.0$ V (VHC) $t_{PD} = 3.1$ ns (Typ) at $V_{CC} = 5.0$ V (VHCT)
- Low Power Dissipation: $I_{CC} = 2 \mu A$ (Max) at $T_A = 25^{\circ}C$
- High Noise Immunity: $V_{NIH} = V_{NIL} = 28\%$
- Power Down Protection Provided
- Balanced Propagation Delays
- Designed for 2 V to 5.5 V Operating Range
- Low Noise: V_{OLP} = 0.8 V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 100 mA
- ESD Performance: Human Body Model > 2000 V
- Chip Complexity: 32 FETs or 8 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

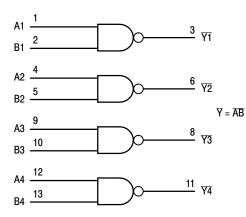
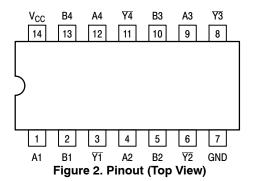


Figure 1. Logic Diagram



FUNCTION TABLE

Inp	uts	Output
Α	в	Y
L	L	Н
L	Н	н
Н	L	н
Н	Н	L

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
V _{IN}	DC Input Voltage		–0.5 to +6.5	V
V _{OUT}	DC Output Voltage (MC74VHC)		–0.5 to V_{CC} + 0.5	V
	DC Output Voltage (MC74VHCT)	Active Mode (High or Low State) Tristate Mode (Note 1) Power-Off Mode (V _{CC} = 0 V)	$\begin{array}{c} -0.5 \text{ to } V_{CC} + 0.5 \\ -0.5 \text{ to } +6.5 \\ -0.5 \text{ to } +6.5 \end{array}$	
I _{IN}	DC Input Current, per Pin		±20	mA
I _{OUT}	DC Output Current, per Pin		±25	mA
I _{CC}	DC Supply Current, V _{CC} and GND Pins		±50	mA
I _{IK}	Input Clamp Current		-20	mA
I _{OK}	Output Clamp Current	MC74VHC MC74VHCT	±20 -20	mA
T _{STG}	Storage Temperature Range		65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
TJ	Junction Temperature Under Bias		±150	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC-14 TSSOP-14	116 150	°C/M
PD	Power Dissipation in Still Air at 25°C	SOIC-14 TSSOP-14	1077 833	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	> 2000 N/A	V
I _{LATCHUP}	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Applicable to devices with outputs that may be tri-stated.
 Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A

(Machine Model) be discontinued. Tested to EIA/JESD78 Class II.

4.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
MC74VHC				
V _{CC}	DC Supply Voltage	2.0	5.5	V
V _{IN}	DC Input Voltage (Note 5)	0	5.5	V
V _{OUT}	DC Output Voltage (Note 5)	0	V _{CC}	V
T _A	Operating Temperature Range	-55	+125	°C
t _r , t _f	Input Rise or Fall Time $V_{CC} = 3$ $V_{CC} = 4$.0 V to 3.6 V 0 .5 V to 5.5 V 0	100 20	ns/V

MC74VHCT

V _{CC}	DC Supply Voltage		2.0	5.5	V
V _{IN}	DC Input Voltage (Note 5)		0	5.5	V
V _{OUT}	DC Output Voltage (Note 5) Active Mode (Hig Power-Off Mo	h or Low State) Tristate Mode ode (V _{CC} = 0 V)	0 0 0	V _{CC} 5.5 5.5	V
T _A	Operating Temperature Range		55	+125	°C
t _r , t _f	Input Rise or Fall Time V _{CC}	= 4.5 V to 5.5 V	0	20	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
5. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

			V _{CC}	٦	Γ _A = 25°0	C	T _A = ≤	≤ 85°C	T _A = ≤	+125°C	
Symbol	Parameter	Test Conditions	v	Min	Тур	Max	Min	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage		2.0 3.0 4.5 5.5	1.5 2.1 3.15 4.2			1.5 2.1 3.15 4.2		1.5 2.1 3.15 4.2		V
V _{IL}	Low-Level Input Voltage		2.0 3.0 4.5 5.5			0.5 0.9 1.35 1.8		0.5 0.9 1.35 1.8		0.5 0.9 1.35 1.8	V
V _{OH} High-Level	$V_{IN} = V_{IH} \text{ or } V_{IL}$									V	
	Output Voltage	I _{OH} = -50 μA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5		1.9 2.9 4.4		1.9 2.9 4.4		
		I _{OH} = -4 mA I _{OH} = -8 mA	3.0 4.5	2.58 3.94			2.48 3.80		2.40 3.70		
V _{OL}	Low-Level	$V_{IN} = V_{IH} \text{ or } V_{IL}$									V
	Output Voltage	I _{OL} = 50 μA	2.0 3.0 4.5		0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1		0.1 0.1 0.1	
		I _{OL} = 4 mA I _{OL} = 8 mA	3.0 4.5			0.36 0.36		0.44 0.44		0.55 0.55	
I _{IN}	Input Leakage Current	$V_{IN} = V_{CC}$ or GND	0 to 5.5			±0.1		±1.0		±1.0	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			2.0		20		40	μΑ

DC ELECTRICAL CHARACTERISTICS (MC74VHC00)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (MC74VHC00)

Power Dissipation Capacitance (Note 6)

				T _A = 25°C		T _A = ≤ 85°C		T _A = ≤+125°C			
Symbol	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay, A or B to \overline{Y}	C _L = 15 pF C _L = 50 pF	3.0 – 3.6		5.5 8.0	7.9 11.4	1.0 1.0	9.5 13.0	1.0 1.0	10 14.5	ns
		C _L = 15 pF C _L = 50 pF	4.5 – 5.5		3.7 5.2	5.5 7.5	1.0 1.0	6.5 8.5	1.0 1.0	7.0 9.5	
C _{in}	Input Capacitance				4.0	10		10		10	pF
							Typical	@ 25°C			

6. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}/4$ (per gate). C_{PD} is used to determine the no–load dynamic power consumption; $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$.

5.0

19

pF

NOISE CHARACTERISTICS

CPD

			T _A = 25°C		
Symbol	Characteristic	Test Conditions	Тур	Max	Unit
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	$V_{CC} = 5.0 V$	0.3	0.8	V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	t _R = t _F = 3.0 ns C _I = 50 pF	-0.3	-0.8	V
V _{IHD}	Minimum High Level Dynamic Input Voltage			3.5	V
V _{ILD}	Maximum Low Level Dynamic Input Voltage			1.5	V

			Vcc	1	Γ _A = 25°0	C	T _A = ≤	≤ 85°C	T _A = ≤ +125°C		
Symbol	Parameter	Test Conditions	V	Min	Тур	Max	Min	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage		3.0 4.5 5.5	1.4 2.0 2.0			1.4 2.0 2.0		1.4 2.0 2.0		V
V _{IL}	Low-Level Input Voltage		3.0 4.5 6.0			0.53 0.8 0.8		0.53 0.8 0.8		0.53 0.8 0.8	V
V _{OH} High-Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$									V	
	I _{OH} = -50 μA	3.0 4.5	2.9 4.4	3.0 4.5		2.9 4.4		2.9 4.4			
		I _{OH} = –4 mA I _{OH} = –8 mA	3.0 4.5	2.58 3.94			2.48 3.80		2.34 3.66		
V _{OL}	Low-Level	$V_{IN} = V_{IH}$ or V_{IL}									V
	Output Voltage	I _{OL} = 50 μA	3.0 4.5		0.0 0.0	0.1 0.1		0.1 0.1		0.1 0.1	
		I _{OL} = 4 mA I _{OL} = 8 mA	3.0 4.5			0.36 0.36		0.44 0.44		0.52 0.52	
I _{IN}	Input Leakage Current	$V_{IN} = 5.5 V \text{ or GND}$	0 to 5.5			±0.1		±1.0		±1.0	μA
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			2.0		20		40	μA
I _{CCT}	Additional Quiescent Supply Current	V_{IN} = 3.4 V, any one input; V_{IN} = V_{CC} or GND, other inputs	5.5			1.35		1.5		1.65	mA
I _{OPD}	Output Leakage Current	V _{OUT} = 5.5 V	0.0			0.5		5.0		10	μA

DC ELECTRICAL CHARACTERISTICS (MC74VHCT00A)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

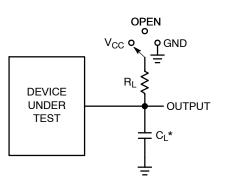
AC ELECTRICAL CHARACTERISTICS (MC74VHCT00A)

				٦	r _A = 25°0	2	T _A = ≤	≤ 85°C	T _A = ≤·	+125°C	
Symbol	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay, A or B to \overline{Y}	C _L = 15 pF C _L = 50 pF	3.0 - 3.6		5.6 8.1	8.0 11.5	1.0 1.0	9.5 13.0		12.0 16.0	ns
		C _L = 15 pF C _L = 50 pF	4.5 – 5.5		3.8 5.3	5.5 7.5	1.0 1.0	6.5 8.5		8.5 10.5	
C _{in}	Input Capacitance				4.0	10		10		10	pF

			Typical @ 25°C	
C _{PD}	Power Dissipation Capacitance (Note 6)	5.0	17	pF

NOISE CHARACTERISTICS

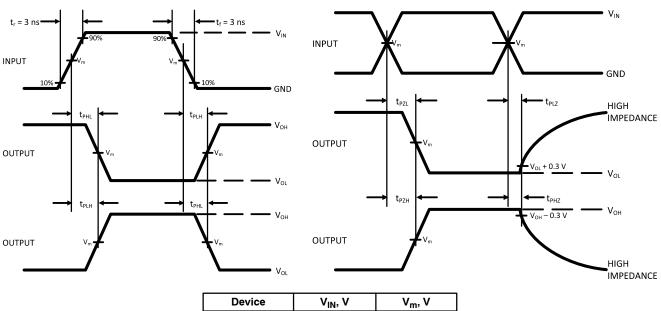
			T _A = 25°C		
Symbol	Characteristic	Test Conditions	Тур	Мах	Unit
V _{OLP}	Quiet Output Maximum Dynamic V_{OL}	$V_{CC} = 5.0 V$	0.4	0.8	V
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	t _R = t _F = 3.0 ns C _L = 50 pF	-0.4	-0.8	V
V _{IHD}	Minimum High Level Dynamic Input Voltage	- '		2.0	V
V _{ILD}	Maximum Low Level Dynamic Input Voltage			0.8	V



Test	Switch Position	CL	RL
t _{PLH} / t _{PHL}	Open	See AC	1 kΩ
t _{PLZ} / t _{PZL}	V _{CC}	Charac- teristics	
t _{PHZ} / t _{PZH}	GND	table	

 $^{*}C_{L}$ Includes probe and jig capacitance

Figure 1. Test Circuit



Device	• IN, •	• m, •
MC74VHC00	V _{CC}	50% x V _{CC}
MC74VHCT00A	3 V	1.5 V

Figure 2. Switching Waveforms

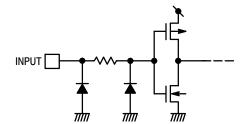
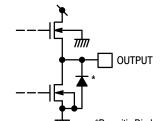


Figure 3. Input Equivalent Circuit (MC74VHC00, MC74VHCT00A)



*Parasitic Diode
Figure 4. Output Equivalent Circuit (MC74VHCT00A)

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74VHC00DR2G	VHC00G	SOIC-14	2500 / Tape & Reel
MC74VHC00DTG	VHC 00	TSSOP-14	96 Units / Rail
MC74VHC00DTR2G	VHC 00	TSSOP-14	2500 / Tape & Reel
MC74VHC00DTR2G-Q*	VHC 00	TSSOP-14	2500 / Tape & Reel
MC74VHCT00ADR2G	VHCT00AG	SOIC-14	2500 / Tape & Reel
MC74VHCT00ADTR2G	VHCT 00A	TSSOP-14	2500 / Tape & Reel
MC74VHCT00ADTR2G-Q*	VHCT 00A	TSSOP-14	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

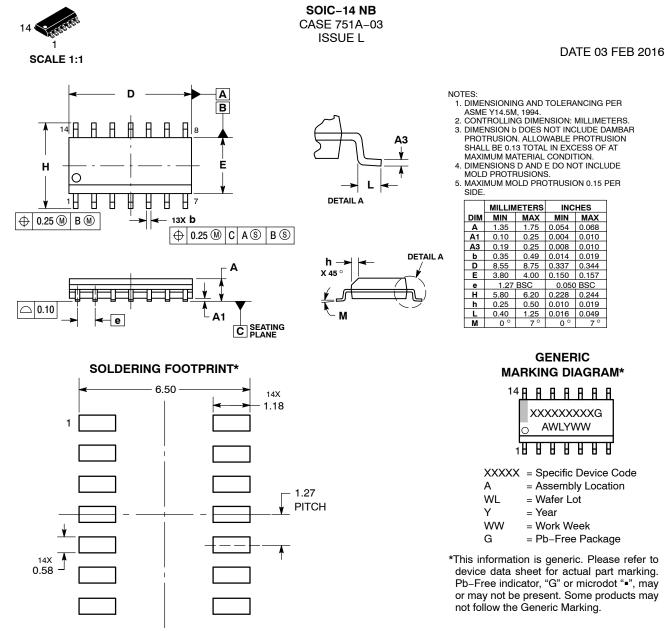
Capable.

DUSEM

0.068

0.019

0.344



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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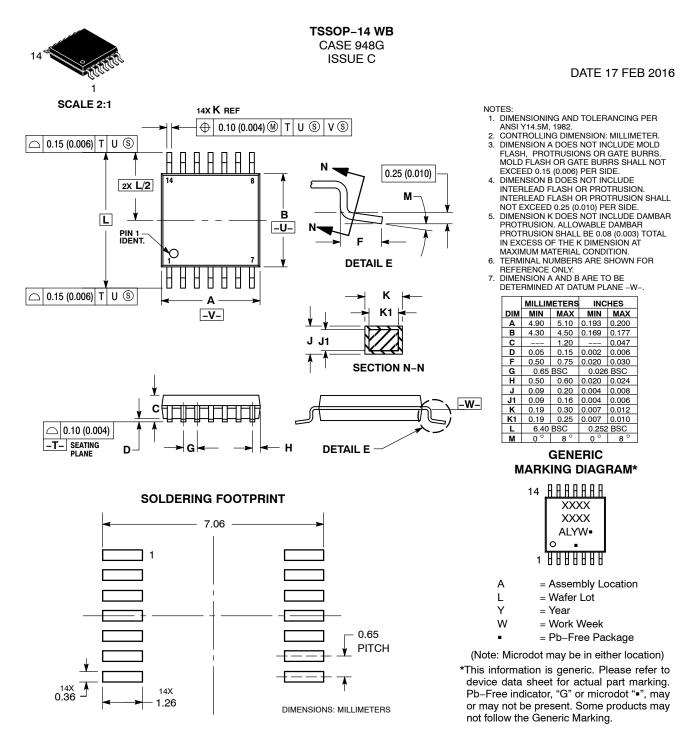
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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